

The GreenMOS[®] high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS[®] Generic series is optimized for extreme switching performance to minimize switching loss. It is tailored for high power density applications to meet the highest efficiency standards.

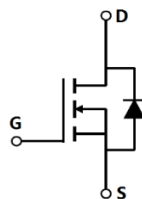



- Low $R_{DS(ON)}$ & FOM
- Extremely low switching loss
- Excellent stability and uniformity

- PC power
- LED lighting
- Telecom power
- Server power
- EV Charger
- Solar/UPS

Parameter	Value	Unit
$V_{DS, min} @ T_{j(max)}$	600	V
$I_D, pulse$	45	A
$R_{DS(ON), max} @ V_{GS}=10V$	290	m
Q_g	13	nC

Product Name	Package	Marking
OSG55R290PF	TO220	OSG55R290P



Absolute Maximum Ratings at $T_j=25^{\circ}\text{C}$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	550	V
Gate-source voltage	V_{GS}	± 30	V
Continuous drain current ¹⁾ , $T_C=25^{\circ}\text{C}$	I_D	15	A
Continuous drain current ¹⁾ , $T_C=100^{\circ}\text{C}$		9.5	
Pulsed drain current ²⁾ , $T_C=25^{\circ}\text{C}$	$I_{D, pulse}$	45	A
Continuous diode forward current ¹⁾ , $T_C=25^{\circ}\text{C}$	I_S	15	A
Diode pulsed current ²⁾ , $T_C=25^{\circ}\text{C}$	$I_{S, pulse}$	45	A
Power dissipation ³⁾ , $T_C=25^{\circ}\text{C}$	P_D	83	W
Single pulsed avalanche energy ⁵⁾	E_{AS}	115	mJ
MOSFET dv/dt ruggedness, $V_{DS}=0\dots 480\text{ V}$	dv/dt	58 reW*n	

Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C_{iss}		678.8		pF	$V_{GS}=0\text{ V}$, $V_{DS}=50\text{ V}$, $f=1\text{ MHz}$
Output capacitance	C_{oss}		80.7		pF	
Reverse transfer capacitance	C_{rss}		3.0		pF	
Turn-on delay time	$t_{d(on)}$		20.8		ns	$V_{GS}=10\text{ V}$, $V_{DS}=400\text{ V}$, $R_G=2\ \Omega$, $I_D=8\text{ A}$
Rise time	t_r		6.3		ns	
Turn-off delay time	$t_{d(off)}$		30.9		ns	
Fall time	t_f		4.0		ns	

Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
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Electrical Characteristics Diagrams

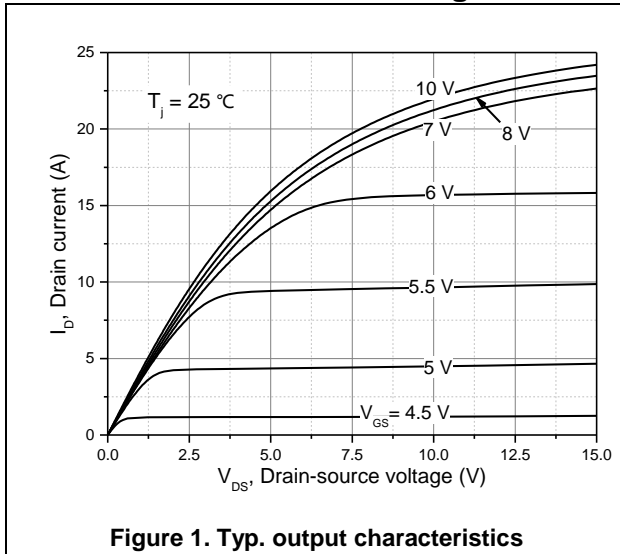


Figure 1. Typ. output characteristics

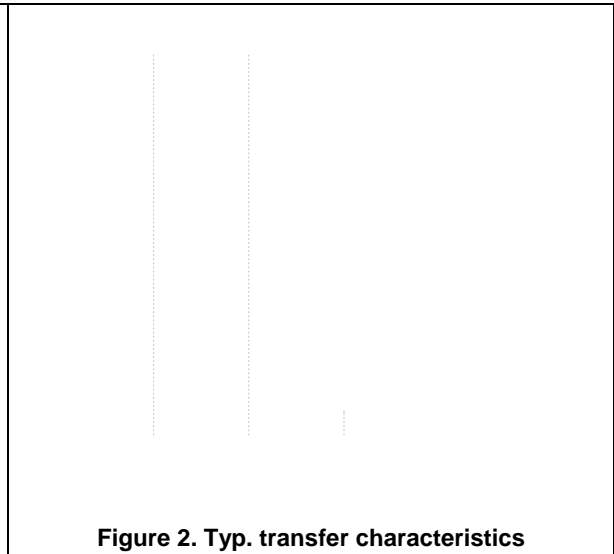


Figure 2. Typ. transfer characteristics

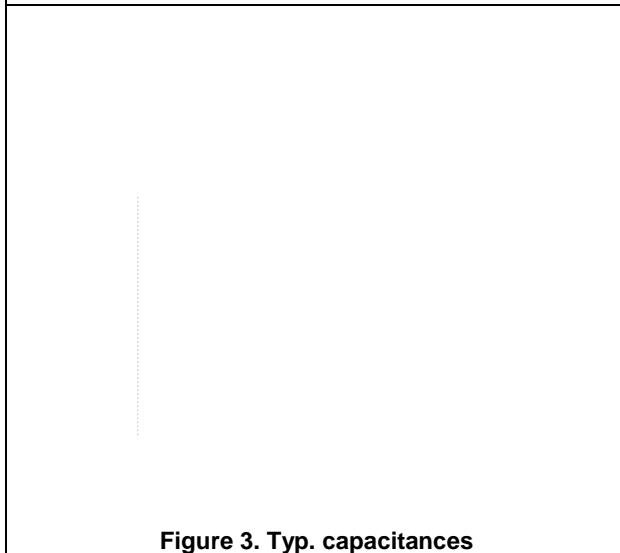


Figure 3. Typ. capacitances

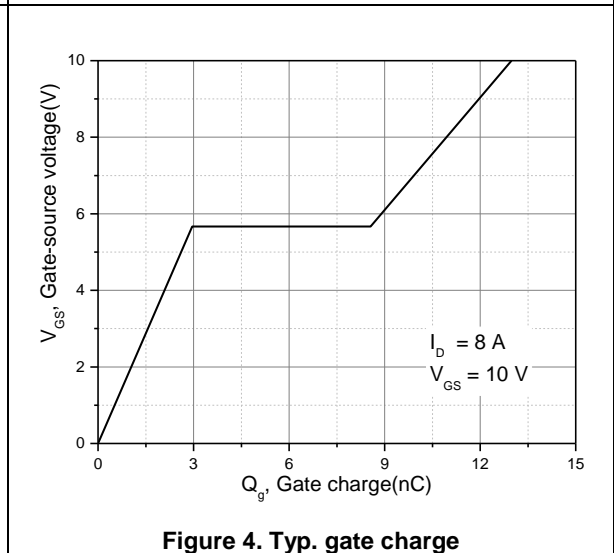


Figure 4. Typ. gate charge

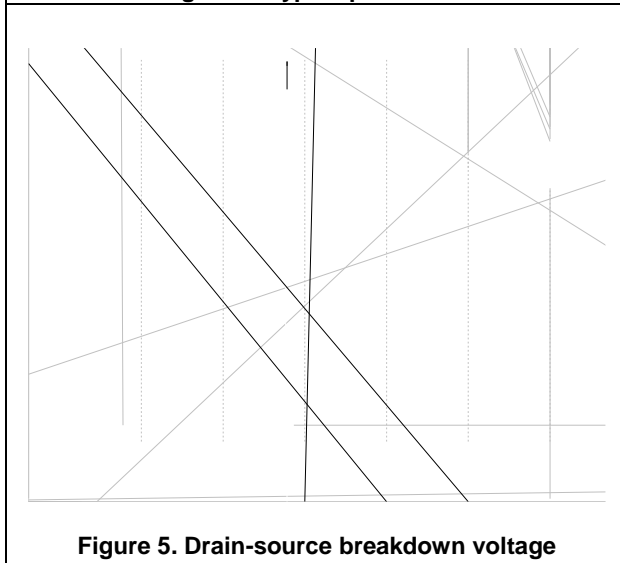


Figure 5. Drain-source breakdown voltage

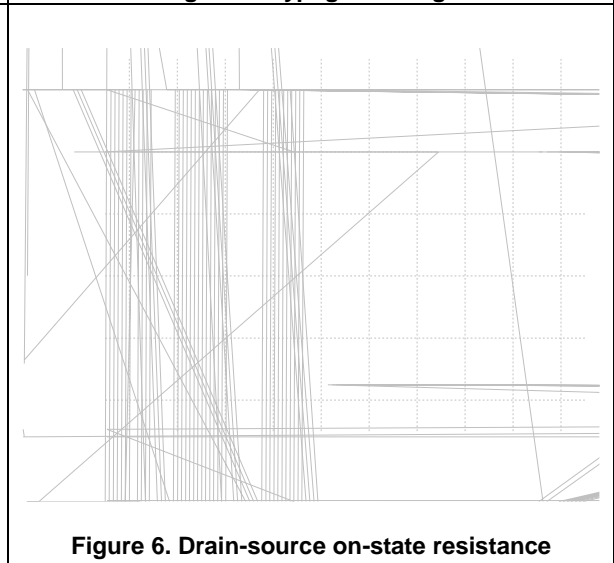


Figure 6. Drain-source on-state resistance

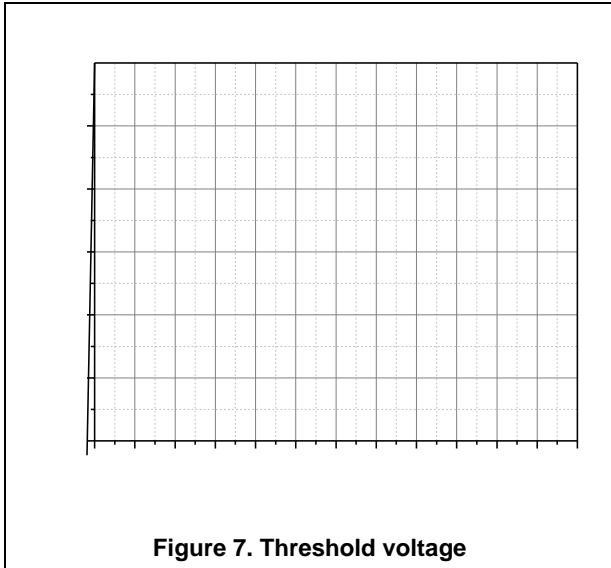


Figure 7. Threshold voltage

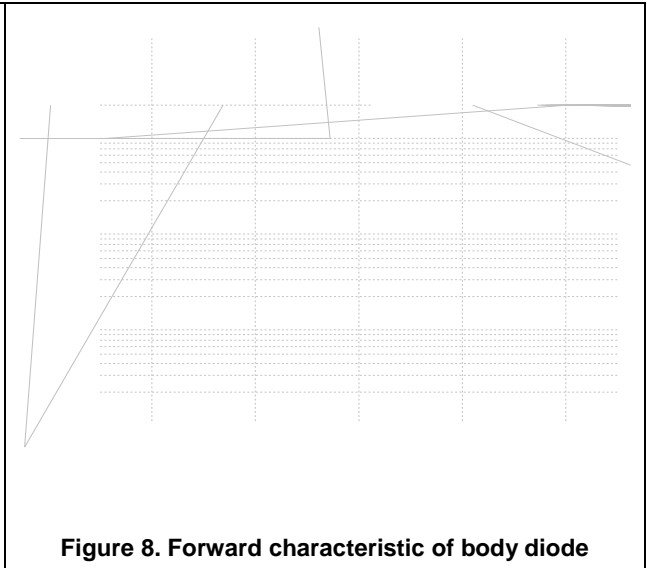


Figure 8. Forward characteristic of body diode

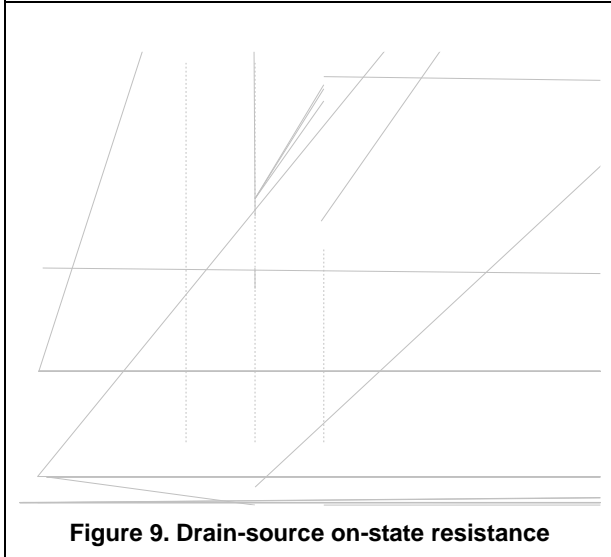


Figure 9. Drain-source on-state resistance

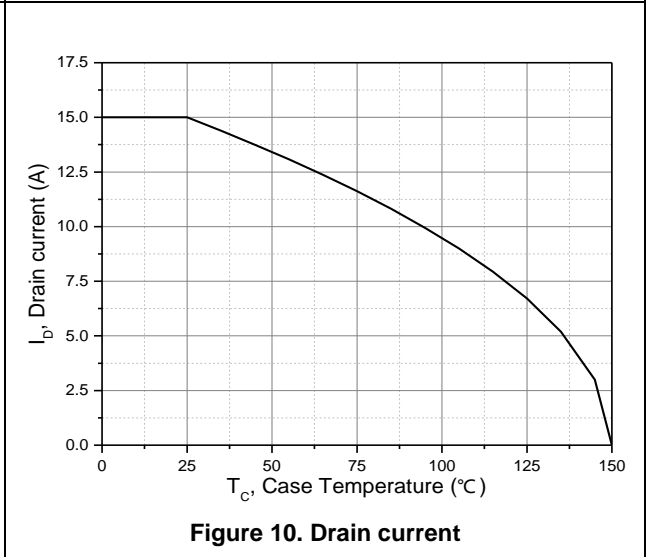


Figure 10. Drain current

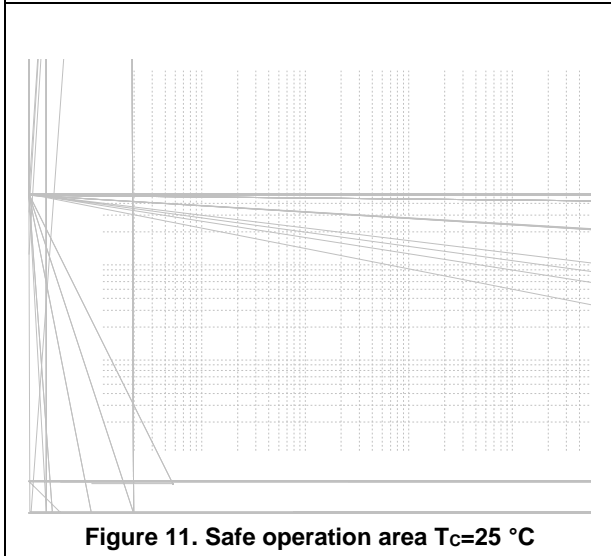


Figure 11. Safe operation area T_C=25 °C

Test circuits and waveforms



Figure 1. Gate charge test circuit & waveform



Figure 2. Switching time test circuit & waveforms

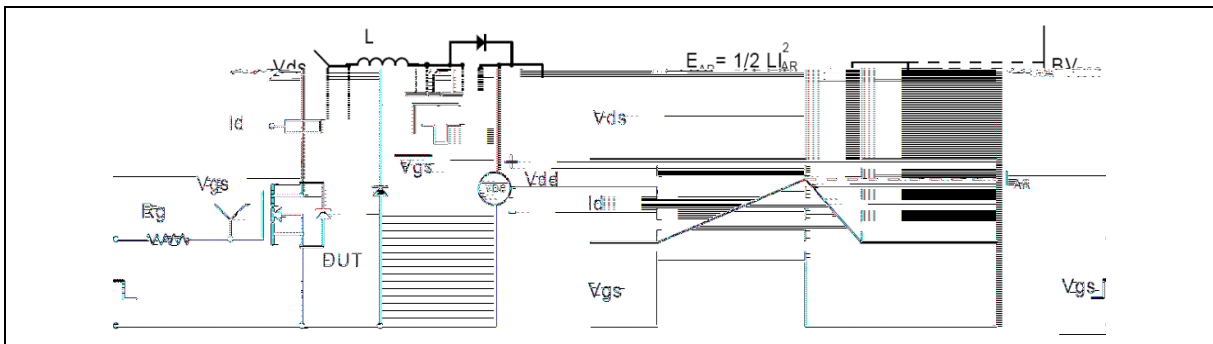


Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms

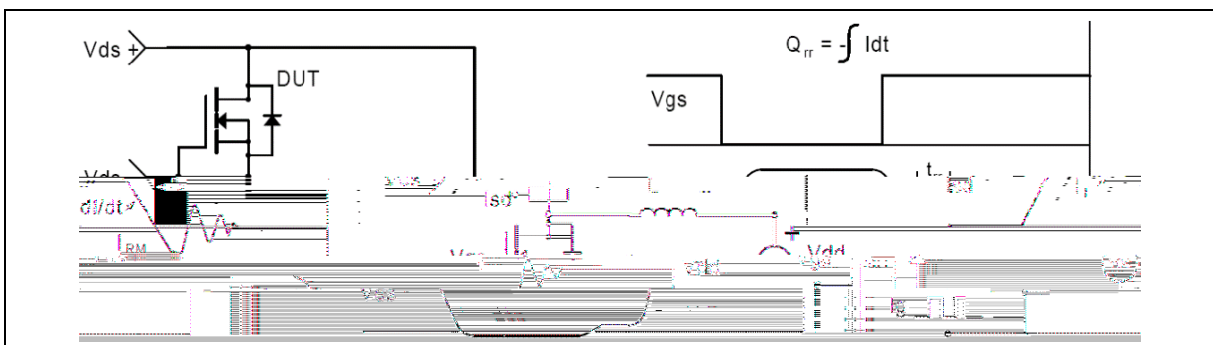


Figure 4. Diode reverse recovery test circuit & waveforms

Package Information

Symbol	Min	mm Nom
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Ordering Information

Package Type	Units/ Tube	Tubes/ Inner Box	Units/ Inner Box	Inner Boxes/ Carton Box	Units/ Carton Box
TO220-C	50	20	1000	6	6000

Product Information

Product	Package	Pb Free	RoHS	Halogen Free
OSG55R290PF	TO220	yes	yes	yes

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